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PreAmend A  
Russell  
9/30/02

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**APPLICANT:** D. Sasaki, et al. **ATTY DOCKET NO.:** 9792909-5175  
**SONY REF. NO.:** S00P0543US01  
**SERIAL NO.** **GROUP ART UNIT:**  
**DATE FILED:** August 2, 2001 **EXAMINER:**  
**INVENTION:** MOUNTING STRUCTURE OF A SEMICONDUCTOR DEVICE,  
AND A PROCESS FOR MOUNTING A SEMICONDUCTOR  
DEVICE ON A MOUNTING SUBSTRATE

which is a Divisional of the following copending U.S. Application:

**APPLICANT:** D. Sasaki, et al. **ATTY DOCKET NO.:** 9792909-0326  
**SONY REF. NO.:** S00P0543US00  
**SERIAL NO.:** 09/561,941 **GROUP ART UNIT:** 2841  
**DATE FILED:** May 1, 2000 **EXAMINER:** H. Bui  
**INVENTION:** MOUNTING STRUCTURE OF A SEMICONDUCTOR DEVICE,  
AND A PROCESS FOR MOUNTING A SEMICONDUCTOR  
DEVICE ON A MOUNTING SUBSTRATE

**PRELIMINARY AMENDMENT**

Assistant Commissioner for Patents  
Washington, DC 20231

Dear Sir:

Please amend the accompanying application as follows:

**In the Specification**

On page 1, after the title and before the heading, "Background of the Invention,"  
please insert the following:

**---RELATED APPLICATION DATA**

This application claims priority to Japanese Application No. P11-132104 filed May  
13, 1999, and is a divisional of United States Application Serial No. 09/561,941, filed May 1,  
2000, both of which are incorporated herein by reference to the extent permitted by law.---